

HSP

NOTES:

Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C
 Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G. F UL94V-0

Ordering Information

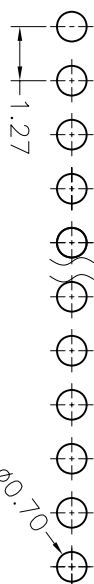
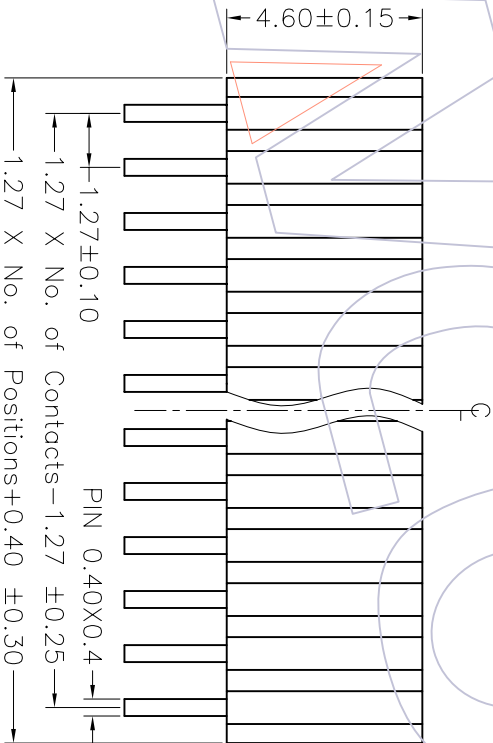
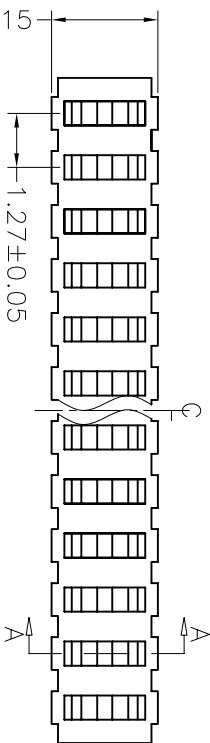
2346 - 1 XX S XX C Y N T X

No. of Pins per ROW: 02-50/PIN

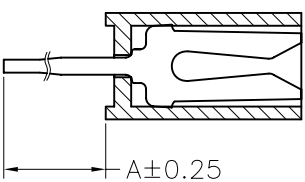
Contact Plating:
 G0=Gold Flash
 G1=3μ"Cold
 G2=5μ"Cold
 G3=10μ"Cold
 G4=15μ"Cold
 G5=30μ"Cold
 S0=Gold Flash/Tin
 S1=3μ"Cold/Tin
 S2=5μ"Cold/Tin
 S3=10μ"Cold/Tin
 S4=15μ"Cold/Tin
 S5=30μ"Cold/Tin
 SN=Tin

Packaging:
 T=Tube

Series No.
 1=DIP:1.6
 2=DIP:2.4
 3=DIP:3.0



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



SECTION A-A

TITLE	PART NO.
A=1.6	2346-1XXSXXCYN1
A=2.4	2346-1XXSXXCYN2
A=3.0	2346-1XXSXXCYN3

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO. LTD

SEE TABLE

1.27mm SINGLE FEMALE HEADER 180° H=4.60

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.
A0	08/02/16	NEW			XXX XXX XXX Angle DIM	DESIGN CHECK APPROVE	6:1 mm A4 1/1	Customer NO.
1					±0.40 ±0.25 ±0.15 ±.3'			